1M x 4 Static RAM

Features

- · High speed
 - $-t_{AA} = 10 \text{ ns}$
- · Low active power for 10 ns speed
 - —540 mW (max.)
- Low CMOS standby power (L version)
 - —1.8 mW (max.)
- 2.0V Data Retention (400 μW at 2.0V retention)
- Automatic power-down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with CE and OE features

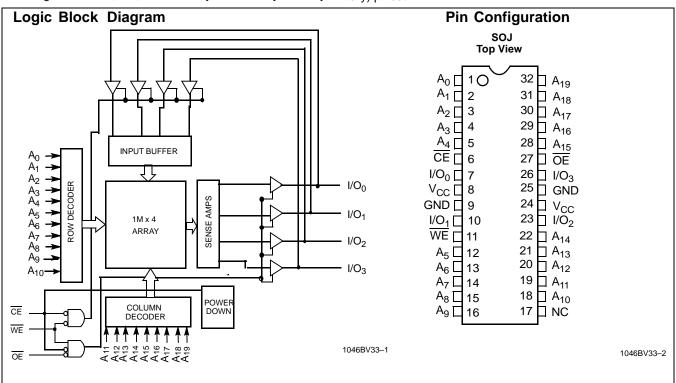
Functional Description

The CY7C1046BV33 is a high-performance CMOS static RAM organized as 1,048,576 words by 4 bits. Easy memory expansion is provided by an active LOW Chip Enable (CE), an active LOW Output Enable (OE), and three-state drivers. Writing to the device is accomplished by taking Chip Enable (CE) and Write Enable (WE) inputs LOW. Data on the four I/O pins (I/O₀ through I/O₃) is then written into the location specified on the address pins (A_0 through A_{19}).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The four input/output pins (I/O₀ through I/O₃) are placed in a high-impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1046BV33 is available in a standard 400-mil-wide 32-pin SOJ package with center power and ground (revolutionary) pinout.



Selection Guide

		7C1046BV33-10	7C1046BV33-12	7C1046BV33-15
Maximum Access Time (ns)	10	12	15	
Maximum Operating Current (mA)	150	140	130	
Maximum CMOS Standby	Com'l	8	8	8
Current (mA)	L version	0.5	0.5	0.5

Shaded areas contain advance information.



Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied......–55°C to +125°C Supply Voltage on V_{CC} to Relative $GND^{[1]}$ -0.5V to +4.6VDC Voltage Applied to Outputs in High Z State $^{[1]}$-0.5V to V_{CC} + 0.5V DC Input Voltage^[1]-0.5V to V_{CC} + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

Operating Range

Range Ambient Temperature ^[2]		v _{cc}
Commercial	0°C to +70°C	3.0V - 3.6V

Electrical Characteristics Over the Operating Range

				7C1046	BV33-10	7C1046	BV33-12	7C1046BV33-15		
Parameter	Description	Test Conditio	ns	Min.	Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -4$	V _{CC} = Min., I _{OH} = -4.0 mA			2.4		2.4		V
V _{OL}	Output LOW Voltage	$V_{CC} = Min., I_{OL} = 8.$.0 mA		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage			2.2	V _{CC} + 0.5	2.2	V _{CC} + 0.5	2.2	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage ^[1]			-0.5	0.8	-0.5	0.8	-0.5	0.8	V
I _{IX}	Input Load Current	$GND \leq V_{I} \leq V_{CC}$		–1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	GND ≤ V _{OUT} ≤ V _{CC} , Output Disabled		- 1	+1	-1	+1	-1	+1	μΑ
I _{CC}	V _{CC} Operating Supply Current	$V_{CC} = Max.,$ $f = f_{MAX} = 1/t_{RC}$			150		140		130	mA
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	$\begin{aligned} &\text{Max. V}_{\text{CC}}, \overline{\text{CE}} \geq \text{V}_{\text{IH}} \\ &\text{V}_{\text{IN}} \geq \text{V}_{\text{IH}} \text{ or} \\ &\text{V}_{\text{IN}} \leq \text{V}_{\text{IL}}, \text{f} = \text{f}_{\text{MAX}} \end{aligned}$	I		20		20		20	mA
I _{SB2}	Power-Down Current	$\label{eq:local_local_local_local} \begin{array}{c c} \underline{\text{Max.}} \ V_{CC}, \\ \hline \text{CE} \geq V_{CC} - 0.3V, \\ V_{\text{IN}} \geq V_{CC} - 0.3V, \\ \text{or } V_{\text{IN}} \leq 0.3V, \\ f = 0 \end{array}$	om'l version		8 0.5		8 0.5		0.5	mA

Shaded areas contain advance information.

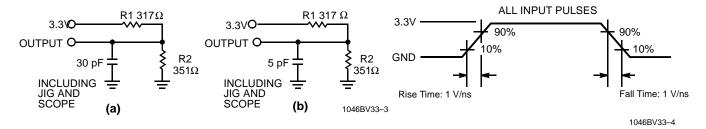
Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	6	pF
C _{OUT}	I/O Capacitance	$V_{CC} = 3.3V$	6	pF

- 1. V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- T_A is the "Instant On" case temperature.
 Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



THÉVENIN EQUIVALENT Equivalent to: 167Ω

Switching Characteristics^[4] Over the Operating Range

		7C1046BV33-10 7C1046BV33-12		7C1046BV33-15				
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYC	LE	•	•			l		
t _{RC}	Read Cycle Time	10		12		15		ns
t _{AA}	Address to Data Valid		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	CE LOW to Data Valid		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		4		6		7	ns
t _{LZOE}	OE LOW to Low Z ^[6]	0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{LZCE}	CE LOW to Low Z ^[6]			3		3		ns
t _{HZCE}	CE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{PU}	CE LOW to Power-Up	0		0		0		ns
t _{PD}	CE HIGH to Power-Down		10		12		15	ns
WRITE CYC	CLE ^[7, 8]							
t _{WC}	Write Cycle Time	10		12		15		ns
t _{SCE}	CE LOW to Write End	7		10		12		ns
t _{AW}	Address Set-Up to Write End	7		10		12		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	7		10		12		ns
t _{SD}	Data Set-Up to Write End	5		7		8		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[6]	3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[5, 6]		5		6		7	ns

Shaded areas contain advance information.

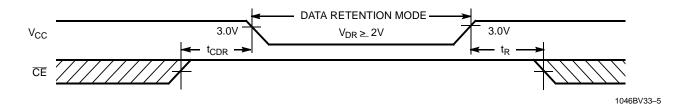
- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- tHZOE, tHZCE, and tHZWE are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE} is less than t_{LZCE}, then the Low to initiate a write, and the transition of either of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write. The minimum write cycle time for Write Cycle no. 3 (WE controlled, OE LOW) is the sum of t_{HZWE} and t_{SD}.



Data Retention Characteristics Over the Operating Range

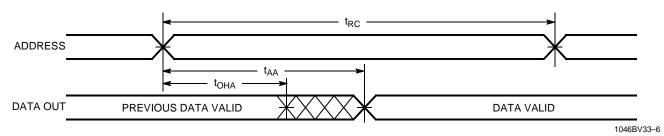
Parameter	Description	Conditions ^[10]	Min.	Max	Unit	
V_{DR}	V _{CC} for Data Retention		2.0		V	
I _{CCDR}	Data Retention Current	Com'l	$\underline{V_{CC}} = V_{DR} = 2.0V$		200	μΑ
t _{CDR} ^[3]	Chip Deselect to Data Retention Time	$\overline{CE} \ge V_{CC} - 0.3V$ $V_{IN} \ge V_{CC} - 0.3V$ or $V_{IN} \le 0.3V$	0		ns	
t _R ^[9]	Operation Recovery Time			10		μs

Data Retention Waveform

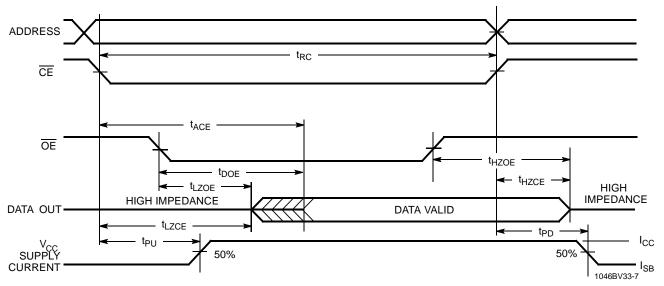


Switching Waveforms

Read Cycle No. 1^[11, 12]



Read Cycle No. 2 (OE Controlled)[12, 13]

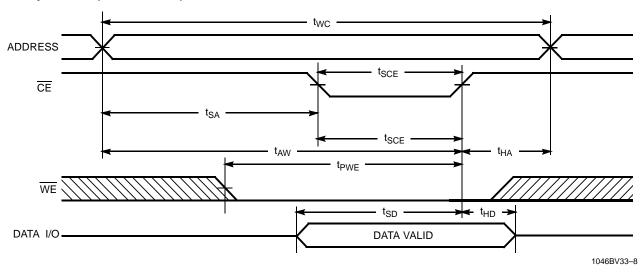


- 9. $t_r \le 3$ ns for the -10, -12, and -15 speeds.
- 10. No input may exceed V_{CC} + 0.5V.
 11. Device is continuously selected. OE, CE = V_{IL}.
- 12. WE is HIGH for read cycle.
- 13. Address valid prior to or coincident with $\overline{\text{CE}}$ transition LOW.

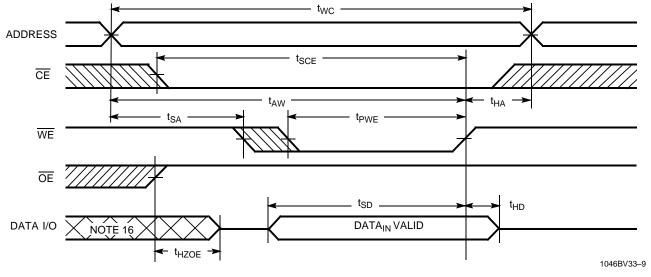


Switching Waveforms (continued)

Write Cycle No. 1 ($\overline{\text{CE}}$ Controlled)[14, 15]



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)[14, 15]

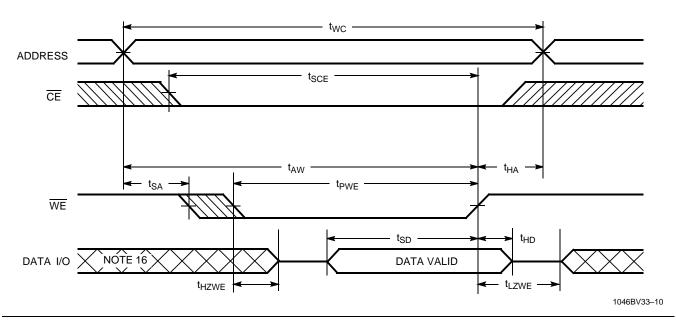


- 14. Data I/O is high impedance if OE = V_{IH}.
 15. If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.
 16. During this period the I/Os are in the output state and input signals should not be applied.



Switching Waveforms (continued)

Write Cycle No. 3 (WE Controlled, OE LOW)^[15]



Truth Table

CE	OE	WE	I/O ₀ - I/O ₇	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

Ordering Information

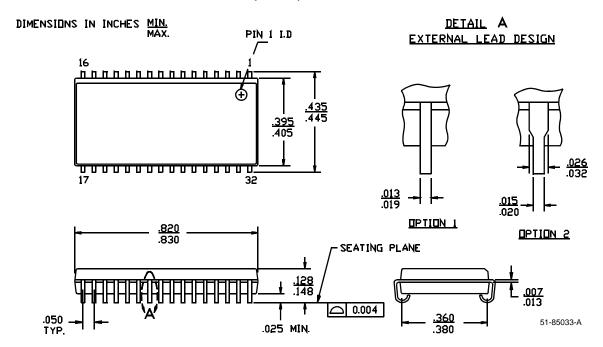
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C1046BV33-10VC	V33	32-Lead (400-Mil) Molded SOJ	Commercial
12	CY7C1046BV33-12VC	V33	32-Lead (400-Mil) Molded SOJ	
15	CY7C1046BV33-15VC	V33	32-Lead (400-Mil) Molded SOJ	
10	CY7C1046BV33L-10VC	V33	32-Lead (400-Mil) Molded SOJ	
12	CY7C1046BV33L-12VC	V33	32-Lead (400-Mil) Molded SOJ	
15	CY7C1046BV33L-15VC	V33	32-Lead (400-Mil) Molded SOJ	

Shaded areas contain pre-release information.



Package Diagram

32-Lead (400-Mil) Molded SOJ V33







	nt Title: CY70 nt Number: 3		1M x 4 Stati	c RAM	
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change	
**	110210	12/02/01	SZV	Change from Spec number: 38-00949 to 38-05170	